

# BGSA400ML10

### Ultra high RF voltage antenna tuning switch

#### Features

- Low  $R_{ON}$  resistance of 2.0  $\Omega$  at each port in ON state
- Low  $C_{OFF}$  capacitance of 165 fF at each port in OFF state
- High RF operating peak voltage handling of typical 90 V in OFF state
- Low harmonic generation
- MIPI RFFE 2.1 control interface
- Extremely low current consumption of 22  $\mu A$
- 4 default USID addresses via external USID\_SEL pin
- Small form factor 1.1 mm x 1.5 mm (MSL1, 260 °C per JEDEC J-STD-020)



- Impedance, antenna and inductance tuning
- Tunable filters

#### **Product validation**

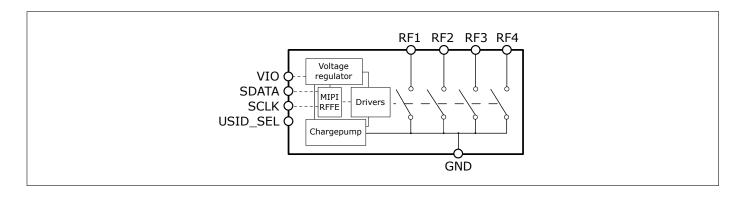
Qualified for industrial applications according to the relevant tests of JEDEC47/20/22.

#### Description

The BGSA400ML10 is a versatile shunt to ground 4xsingle-pole single-throw (4xSPST) RF antenna tuning switch. It is optimized for low  $C_{OFF}$  as well as low  $R_{ON}$  enabling applications up to 7.125 GHz.

The BGSA400ML10 is ideal for antenna tuning application. This chip integrates on-chip CMOS logic and power supply regulation. Its digital control interface is compliant with MIPI2.1 RFFE specification and each switch throw can be programmed individually or all together in the same RFFE command frame. Up to 4 instantiations of the same device can be controlled using the same RFFE bus thanks to its 4 states USID\_SEL pin unique feature.

#### **Block diagram**



Туре	Marking	Package	Ordering information
BGSA400ML10	4T	TSLP-10-3	BGSA 400ML10 E6327



## BGSA400ML10

Ultra high RF voltage antenna tuning switch

Table of contents

### **Table of contents**

1	Maximum ratings	2
2	DC characteristics	4
3	RF small signal characteristics	5
4	RF large signal characteristics	7
5	MIPI RFFE specification	9
6	Application information	17
7	Package information	19





**Maximum ratings** 

### **1** Maximum ratings

Parameter	Symbol		Value	S	Unit	Note / Test condition	
		Min. Typ. Max.		Max.			
Frequency range	f	0.4	-	7.125	GHz	1)	
RFFE supply voltage <sup>2)</sup>	V <sub>IO</sub>	-0.3	-	2.2	V	Only for infrequent and short	
						duration time periods	
Storage temperature range	T <sub>STG</sub>	-55	-	150	°C	-	
RF peak voltage	V <sub>RF_max</sub>	-	-	90	V	Short term peaks (1 µs in 0.1%	
						duty cycle), exceeding typical	
						linearity, <i>R</i> <sub>ON</sub> and <i>C</i> <sub>OFF</sub> param-	
						eters, in isolation mode, test	
						condition schematic in Fig. 1	
ESD robustness, CDM <sup>3)</sup>	V <sub>ESDcdm</sub>	-1	-	+1	kV		
ESD robustness, HBM <sup>4)</sup>	V <sub>ESDHBM</sub>	-2	-	+2	kV		
Junction temperature	Tj	-	-	125	°C	-	
Thermal resistance junction - soldering point	R <sub>thJS</sub>	-	-	50	K/W	-	
Maximum DC-voltage on RF-Ports and RF-	V <sub>RFDC</sub>	0	-	0	V	No DC voltage allowed on RF-	
Ground						Ports	
RFFE control voltage levels	V <sub>SCLK</sub> ,	-0.7	-	V <sub>IO</sub> +0.7	V	-	
	V <sub>SDATA</sub> ,			(max.			
	V <sub>USID_SEL</sub>			2.2)			

#### **Table 1: Maximum ratings table** at $T_A = 25$ °C, unless otherwise specified

<sup>1)</sup> Switch has a low-pass response. For higher frequencies, losses have to be considered for their impact on thermal heating. The DC voltage at RF ports V<sub>RFDC</sub> has to be 0 V.

<sup>2)</sup> Note: Consider any ripple voltages on top of  $V_{IO}$ . A high RF ripple at the  $V_{IO}$  can exceed the maximum ratings by  $V_{IO} = V_{DC} + V_{Ripple}$ .

<sup>3)</sup> Field-Induced Charged-Device Model ANSI/ESDA/JEDEC JS-002. Simulates charging/discharging events that occur in production equipment and processes. Potential for CDM ESD events occurs whenever there is metal-to-metal contact in manufacturing.

 $^{4)}$  Human Body Model ANSI/ESDA/JEDEC JS-001 (R=1.5 k\Omega, C=100 pF).

Warning: Stresses above the max. values listed here may cause permanent damage to the device. Maximum ratings are absolute ratings; exceeding only one of these values may cause irreversible damage to the integrated circuit. Exposure to conditions at or below absolute maximum rating but above the specified maximum operation conditions may affect device reliability and life time. Functionality of the device might not be given under these conditions.



#### **Maximum ratings**

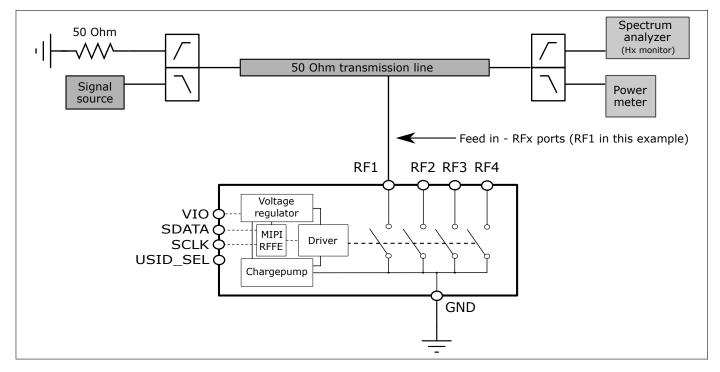


Figure 1: RF operating voltage and harmonic distortion measurement configuration



DC characteristics

### 2 DC characteristics

**Table 2: DC characteristics** at  $T_A = -40$  °C to 85 °C

Parameter	Symbol		Values		Unit	Note / Test condition
		Min.	Тур.	Max.		
RFFE supply voltage	V <sub>IO</sub>	1.65	1.8	1.95	V	-
RFFE input high voltage <sup>1</sup>	V <sub>IH</sub>	0.7*V <sub>IO</sub>	-	V <sub>IO</sub>	V	-
RFFE input low voltage <sup>1</sup>	V <sub>IL</sub>	0	-	0.3*V <sub>IO</sub>	V	-
RFFE output high voltage <sup>1</sup>	V <sub>OH</sub>	0.8*V <sub>IO</sub>	-	V <sub>IO</sub>	V	-
RFFE output low voltage <sup>1</sup>	V <sub>OL</sub>	0	-	0.2*V <sub>IO</sub>	V	-
RFFE control input capacitance	C <sub>Ctrl</sub>	-	-	2	pF	-
		-	22	40	μΑ	ACTIVE mode,
						$\leq$ 35 dBm RF power
RFFE supply current <sup>2</sup>	I <sub>VIO</sub>	-	2	8	μA	SECONDARY_ACTIVE mode
						(LOW POWER) with analog
		-	0.5 <sup>3</sup>	1 <sup>3</sup>	μA	circuitry powered OFF

<sup>1</sup>SCLK and SDATA

<sup>2</sup>No traffic on MIPI bus <sup>3</sup>Supply current reduced after first MIPI RFFE command



**RF small signal characteristics** 

## 3 RF small signal characteristics

#### Table 3: Parametric specifications for each SPST

Parameter	Symbol	Symbol Values		Unit	State / Notes	
		Min.	Тур.	Max.		
RF1, RF2, RF3 or RF4 to GND	R <sub>ONSPST</sub>	-	2.0	2.2	Ω	
DC ON resistance						
RF1, RF2, RF3 or RF4 to GND	COFFSPST	-	165	180	fF	$V_{IO} = 1.65 - 1.95 \text{ V},$
OFF capacitance, 1 GHz						$T_{\rm A} = 25 ^{\circ}{\rm C},$ $Z_0 = 50 \Omega$
RF1, RF2, RF3 or RF4 to GND	R <sub>OFFspst</sub>	170	260	-	kΩ	-20 - 20.75
DC OFF resistance						



**RF small signal characteristics** 

#### Table 4: RF electrical parameters

#### Isolation between adjacent RF ports (All OFF / Isolation mode) $^{1)}$

Frequency range	Symbol	Values			Unit	State / Notes
		Min.	Тур.	Max.	_	
600 - 960 MHz		30	37	-	dB	
1160 - 1300 MHz		28	33	-	dB	
1400 - 1700 MHz		26	31	-	dB	
1700 - 2200 MHz		23	29	-	dB	State 0,
2200 - 2700 MHz	ISO	21	27	-	dB	$V_{IO} = 1.65 - 1.95 \text{ V}, Z_0 = 50 \Omega$
3300 - 4200 MHz		19	24	-	dB	$T_A = -40 ^{\circ}\text{C} + 85 ^{\circ}\text{C}$
4400 - 5000 MHz		17	23	-	dB	
5150 - 5925 MHz		15	22	-	dB	
5950 - 7125 MHz		15	22	-	dB	
Isolation between non-ac	ljacent RF ports (/	ll OFF / Is	olation m	ode) <sup>1)</sup>		1
600 - 960 MHz		50	60	-	dB	
1160 - 1300 MHz		47	56	-	dB	
1400 - 1700 MHz		46	55	-	dB	
1700 - 2200 MHz		45	53	-	dB	State 0,
2200 - 2700 MHz	ISO	43	51	-	dB	$V_{IO}$ = 1.65 - 1.95 V, $Z_0$ = 50 $\Omega$
3300 - 4200 MHz		40	48	-	dB	$T_A = -40 ^{\circ}\text{C} + 85 ^{\circ}\text{C}$
4400 - 5000 MHz		35	48	_	dB	
5150 - 5925 MHz		35	47	-	dB	
5950 - 7125 MHz		35	49	-	dB	
Isolation between adjace	nt RF ports (RFx C	N mode) <sup>1</sup>	L)			
600 - 960 MHz		30	47	-	dB	
1160 - 1300 MHz		28	42	-	dB	
1400 - 1700 MHz		25	39	-	dB	
1700 - 2200 MHz		23	36	-	dB	State 1, 2, 4, 8,
2200 - 2700 MHz	ISO	21	33	-	dB	$V_{IO} = 1.65 - 1.95 \text{ V}, Z_0 = 50 \Omega$
3300 - 4200 MHz		19	28	-	dB	$T_A = -40 ^{\circ}\text{C} + 85 ^{\circ}\text{C}$
4400 - 5000 MHz		17	26	-	dB	-
5150 - 5925 MHz		15	24	-	dB	
5950 - 7125 MHz		15	22	-	dB	
Isolation between non-ac	ljacent RF ports (I	RFx ON mo	ode) 1)			
600 - 960 MHz		50	67	-	dB	
1160 - 1300 MHz		48	61	-	dB	-
1400 - 1700 MHz		46	58	-	dB	-
1700 - 2200 MHz		45	56	-	dB	State 1, 2, 4, 8,
2200 - 2700 MHz	ISO	43	53	-	dB	$V_{IO} = 1.65 - 1.95 \text{ V}, Z_0 = 50 \Omega_{IO}$
3300 - 4200 MHz		35	49	-	dB	$T_{A} = -40 ^{\circ}\text{C} + 85 ^{\circ}\text{C}$
4400 - 5000 MHz		33	47	-	dB	
5150 - 5925 MHz		30	45	-	dB	-
5950 - 7125 MHz		28	43	_	dB	-

<sup>1)</sup>On application board without any matching components



**RF large signal characteristics** 

## 4 RF large signal characteristics

Parameter	Symbol		Values		Unit	Note / Test condition	
		Min.	Тур.	Max.			
RF operating voltage	V <sub>RF_opr</sub>	-	-	85	V	In isolation mode, 900MHz, Tes condition schematic in Fig. 1, $T_A = 25 \degree C$	
Harmonic distortion, off mo	de						
All RF ports Second order harmonics	P <sub>H2</sub>	-	-95	-85	dBm	26 dBm, 50 $\Omega$ , $f_0$ = 663 MHz	
All RF ports Third order harmonics	P <sub>H3</sub>	-	-100	-90	dBm	26 dBm, 50 Ω, $f_0$ = 663 MHz	
All RF ports Second order harmonics	P <sub>H2</sub>	-	-75	-65	dBm	35 dBm, 50 Ω, $f_0$ = 920 MHz	
All RF ports Third order harmonics	P <sub>H3</sub>	-	-82	-72	dBm	35 dBm, 50 Ω, $f_0$ = 920 MHz	
All RF ports Second order harmonics	P <sub>H2</sub>	-	-75	-65	dBm	33 dBm, 50 Ω, $f_0$ = 1910 MHz	
All RF ports Third order harmonics	P <sub>H3</sub>	-	-83	-73	dBm	33 dBm, 50 Ω, $f_0$ = 1910 MHz	
All RF ports Second order harmonics	P <sub>H2</sub>	-	-82	-72	dBm	29 dBm, 50 Ω, $f_0$ = 2690 MHz	
All RF ports Third order harmonics	P <sub>H3</sub>	-	-88	-78	dBm	29 dBm, 50 Ω, $f_0$ = 2690 MHz	
All RF ports Second order harmonics	P <sub>H2</sub>	-	-77	-67	dBm	29 dBm, 50 $\Omega$ , $f_0$ = 3600 MHz	
All RF ports Third order harmonics	P <sub>H3</sub>	-	-90	-80	dBm	29 dBm, 50 $\Omega$ , $f_0$ = 3600 MHz	
All RF ports Second order harmonics	P <sub>H2</sub>	-	-75	-65	dBm	29 dBm, 50 $\Omega$ , $f_0$ = 4400 MHz	
All RF ports Third order harmonics	P <sub>H3</sub>	-	-85	-75	dBm	29 dBm, 50 $\Omega$ , $f_0$ = 4400 MHz	
All RF ports Second order harmonics	P <sub>H2</sub>	-	-75	-65	dBm	29 dBm, 50 $\Omega$ , $f_0$ = 5000 MHz	
All RF ports Third order harmonics	P <sub>H3</sub>	-	-85	-75	dBm	29 dBm, 50 Ω, $f_0$ = 5000 MHz	
All RF ports > Third order harmonics	P <sub>Hx</sub>	-	-	-80	dBm	29 dBm, 50 Ω	

Table 5: RF large signal specifications at  $T_A = -40 \text{ °C...} + 85 \text{ °C}$ , unless otherwise specified



#### **RF large signal characteristics**

#### Parameter Symbol Values Unit Note / Test condition Min. Тур. Max. **Intermodulation distortion IIP2** IIP2, low 120 IIP2,l 135 \_ dBm IIP2 conditions in Tab. 7 IIP2, high IIP2,h 125 dBm 135 \_ **Intermodulation distortion IIP3** IIP3 IIP3 74 82 \_ dBm IIP3 conditions in Tab. 8

#### **Table 6: RF large signal specifications** at $T_A = -40$ °C... + 85 °C, unless otherwise specified

#### Table 7: IIP2 conditions table

Band	In-band frequency	Blocker frequency 1	Blocker power 1	Blocker frequency 2	Blocker power 2
	[MHz]	[MHz]	[dBm]	[MHz]	[dBm]
Band 1 low	2140	1950	20	190	0
Band 1 high	2140	1950	20	4090	0
Band 5 low	881.5	836.5	20	45	0
Band 5 high	881.5	836.5	20	1718	0
Band 7 low	2655	2535	20	120	0
Band 7 high	2655	2535	20	5910	0

#### Table 8: IIP3 conditions table

Band	In-band frequency	Blocker frequency 1	Blocker power 1	Blocker frequency 2	Blocker power 2
	[MHz]	[MHz]	[dBm]	[MHz]	[dBm]
Band 1	2140	1950	20	1760	0
Band 5	881.5	836.5	20	791.5	0
Band 7	2655	2535	20	2415	0



**MIPI RFFE specification** 

### **5 MIPI RFFE specification**

The MIPI RFFE interface is implemented according to the following specifications and documents:

- MIPI Alliance Specification for RF Front-End Control Interface Version 2.1 18 December 2017
- MIPI Alliance Errata 01 for MIPI RFFE Specification Version v2.1 24 February 2019
- Qualcomm RFFE Vendor Specification 80-N7876-1 Rev. Y (December 3, 2018)

#### Table 9: MIPI features

Feature	Supported	Comment
MIPI RFFE 2.1 standard	Yes	Backward compatible to MIPI 2.0 standard
Register 0 write command sequence	Yes	
Register read and write command sequence	Yes	
Extended register read and write command sequence	Yes	
Masked write command sequence	Yes	Indicated as MW in below register mapping tables
Support for standard frequency range operations for	Yes	Up to 26 MHz
SCLK		
Support for extended frequency range operations for	Yes	Up to 52 MHz
SCLK		
Longer reach RFFE bus length feature	Yes	
Programmable driver strength	Yes	Up to 80 pF
Programmable Group SID	Yes	
Programmable USID	Yes	
Trigger functionality	Yes	
Extended triggers and trigger masks	Yes	
Broadcast / GSID write to PM TRIG register	Yes	
Reset	Yes	Via VIO, PM TRIG or software register
Status / error sum register	Yes	
Extended product ID register	Yes	
Revision ID register	Yes	
Group SID register	Yes	
USID select pin	Yes	See Tab. 16

#### Table 10: Startup behavior

Feature	State	Comment
Power status	Low power	Device in SECONDARY_ACTIVE mode (LOW POWER) after start-up
Trigger function	Enabled	Enabled after start-up. Programmable via behavior control register



#### **MIPI RFFE specification**

Parameter	Symbol		Values		Unit	State / Notes	
		Min.	Тур.	Max.			
ON switching time	t <sub>st,ON</sub>	-	-	20	μs	50% last SCLK rising edge of the reg	
						ister write command to 10% of RF	
						amplitude, see Fig. 2	
OFF switching time	t <sub>ST,OFF</sub>	-	-	5	μs	50% last SCLK rising edge of the reg	
						ister write command to 90% of RF	
						amplitude, see Fig. 2	

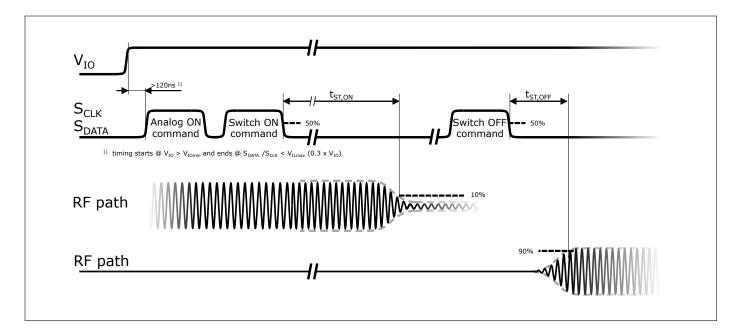


Figure 2: BGSA400ML10 switching time behavior



### MIPI RFFE specification

#### Table 12: Register mapping, table I

Register address	Register name	Data bits	Function	Description	Default	Broadcast_ID support	Trigger support	R/W
0x00	REGISTER_0	7:0	MODE_CTRL	RF switch control	00000000	No	Yes	R/W
							Trigger 0-10	мw
0x01	REGISTER_1	7:0	MODE_CTRL	RF Switch Control	00000000	000 No	Yes	R/W
							Trigger 0-10	MW
0x1C	PM_TRIG	7	PWR_MODE(1)	0: Normal operation (ACTIVE)	1	Yes	No	R/W
			Operation mode	1: Low power mode				мw
				(SECONDARY_ACTIVE)				
		6	PWR_MODE(0)	0: No action (ACTIVE)	0			
			State bit vector	1: Powered reset (ACTIVE to STARTUP)			-	
		5	TRIGGER_MASK_2	0: Data masked (held in shadow REG)	0	No		
				1: Data not masked (ready for transfer to active REG)				
		4	TRIGGER_MASK_1	0: Data masked (held in shadow REG)	0			
				1: Data not masked (ready for transfer to active REG)		-		
		3	TRIGGER_MASK_0	0: Data masked (held in shadow REG)	0			
				1: Data not masked (ready for transfer to active REG)				
		2	TRIGGER_2	0: No action (data held in shadow REG)	0	Yes		
				1: Data transferred to active REG		_		
		1	TRIGGER_1	0: No action (data held in shadow REG)				
				1: Data transferred to active REG				
		0	TRIGGER_0	0: No action (data held in shadow REG)	0			
				1: Data transferred to active REG				
0x1D	PRODUCT_ID	7:0	PRODUCT_ID	This is a read-only register. However, during the programming of the USID a write command sequence is performed on this register, even though the write does not change its value.	11111100	No	No	R
0x1E	MAN_ID	7:0	MANUFACTURER_ID [7:0]	This is a read-only register. However, during the programming of the USID, a write command sequence is performed on this register, even though the write does not change its value.	00011010	No	No	R
0x1F	MAN_USID	7:4	MANUFACTURER_ID [11:8]	These bits are read-only. However, dur- ing the programming of the USID, a write command sequence is performed on this register even though the write does not change its value.	0001			
		3:0	USID[3:0]	USID_Sel pin	See Tab. 16	No	No	R/W



### **MIPI RFFE specification**

#### Table 13: Register mapping, table II

r Register name Data Function Description bits		Default	Broadcast_ID support	Trigger support	R/W		
EXT_PRODUCT_ID	7:0	EXT_PRODUCT_ID	Extension to PRODUCT_ID in register 0x1D. This is a read-only register. How- ever, during the programming of the USID a write command sequence is per- formed on this register, even though the write does not change its value.	0000000	No	No	R
REV_ID	7:4	MAIN_REVISION	Chip main revision	0000	No	No	R
	3:0	SUB_REVISION	Chip sub revision	0000			
GSID	7:4	GSID0[3:0]	Primary group slave ID.	0000	No	No	R/W
	3:0	GSID1[3:0]	Secondary group slave ID.	0000			
UDR_RST				0	Yes	No	R/W
	6:0	RESERVED	Reserved for future use	0000000			
ERR_SUM	7	RESERVED	Reserved for future use	0	No	No	R
	6	COMMAND_FRAME_PARITY_ERR	Command sSequence received with par- ity error — discard command.	0			
	5	COMMAND_LENGTH_ERR	Command length error.	0			
	4	ADDRESS_FRAME_PARITY_ERR	Address frame with parity error.	0			
	3	DATA_FRAME_PARITY_ERR	Data frame with parity error.	0			
	2	READ_UNUSED_REG	Read command to an invalid address.	0			
	1	WRITE_UNUSED_REG	Write command to an invalid address.	0			
	0	BID_GID_ERR	Read command with a BROADCAST_ID or GROUP_ID.	0			
BUS_LD	7:3	RESERVED	Reserved for future use	0x0	No	No	R/W
	2:0	BUS_LD[2:0]	Program the drive strength of the SDATA driver in readback modes. 0x0: 10 pF 0x1: 20 pF 0x2: 30 pF 0x3: 40 pF 0x4: 50 pF 0x5: 60 pF 0x6: 80 pF 0x7: 80 pF	0x4			
	REV_ID GSID UDR_RST ERR_SUM	REV_ID       7:4         3:0       3:0         GSID       7:4         3:0       3:0         UDR_RST       7         6:0       6:0         ERR_SUM       7         6       5         4       3         2       1         0       0	REV_ID7:4MAIN_REVISION3:0SUB_REVISIONGSID7:4GSID0[3:0]3:0GSID1[3:0]UDR_RST7UDR_RST6:0RESERVEDERR_SUM7RESERVED6COMMAND_FRAME_PARITY_ERR5COMMAND_LENGTH_ERR4ADDRESS_FRAME_PARITY_ERR3DATA_FRAME_PARITY_ERR2READ_UNUSED_REG1WRITE_UNUSED_REG0BID_GID_ERRBUS_LD7:3RESERVED	Image: Sum of the second sec	Build State         Dx1D. This is a read-only register. How- ever, during the programming of the USDB awrite command sequence is per- formed on this register, even though the write does not change its value.           REV_ID         7:4         MAIN_REVISION         Chip main revision         0000           3:0         SUB_REVISION         Chip sub revision         0000           GSID         7:4         GSID0[3:0]         Primary group slave ID.         0000           3:0         GSID1[3:0]         Secondary group slave ID.         0000           UDR_RST         7         UDR_RST         Reset all configurable non-RFFE Re- served registers to default values.         0           6:0         RESERVED         Reserved for future use         0         0           6:0         RESERVED         Reserved for future use         0         0           6:1         COMMAND_FRAME_PARITY_ERR         Command Sequence received with par- ity error – discard command.         0           5         COMMAND_FRAME_PARITY_ERR         Data frame with parity error.         0           4         ADDRESS_FRAME_PARITY_ERR         Data frame with parity error.         0           2         READ_UNUSED_REG         Read command to an invalid address.         0           8US_LD         2:0         BUS_LD_REG         Reserved for future use <td>EXT_PRODUCT_ID         7.0         EXT_PRODUCT_ID         Extension to PRODUCT_ID in register OXLD. This is a read-only register. How ever, during the programming of the USID a write command sequence is per- formed on this register, even though the write does not change its value.         00000         No           REV_ID         7.4         MAIN_REVISION         Chip sub revision         0000         No           GSID         7.4         GSID0[3:0]         Primary group slave ID.         0000         No           UDR_RST         7         UDR_RST         Reset all configurable non-RFFE Re- served registers to default values. 0: Normal operation         0         0         Ves           ERR_SUM         7         RESERVED         Reset all configurable non-RFFE Re- served registers to default values. 0: Normal operation         0         Ves           6:0         RESERVED         Reserved for future use         0         0         No           6:1         COMMAND_FRAME_PARITY_ERR         Command Sequence received with par- ity error - discard command.         0         No           7         BID_GID_ERR         Read command to an invalid address.         0         0           7         RESERVED         Read command to an invalid address.         0         0           6         COMMAND_LENGTH_ERR         Command senge write parity error.         0</td> <td>EXT_PRODUCT_ID         7.0         EXT_PRODUCT_ID         Extension to PRODUCT_ID in register OLD. This is a read-only register. How- ever, during the programming of the USD a write command sequence is per- formed on this register, even though the write does not change its value.         000000         No         No           REV_ID         7.4         MAIN_REVISION         Chip main revision         0000         No         No           GSID         7.4         GSID0(3:0)         Primary group slave ID.         0000         No         No           3:0         SUB_REVISION         Chip sub revision         00000         No         No           GSID         7.4         GSID0(3:0)         Primary group slave ID.         0000         No         No           0         3:0         GSID12:0)         Secondary group slave ID.         00000         No         No           UDR_RST         7         UDR_RST         Reset all configurable non-RFFE Re- served for future use         0         No         No           6:0         RESERVED         Reserved for future use         0         No         No           4         ADDRESS_FRAME_PARITY_ERR         Command Sequence received with par- ity error - discard command.         0         No           1         WRITE_UNUSED_REG         Write command to an invalid addrer</td>	EXT_PRODUCT_ID         7.0         EXT_PRODUCT_ID         Extension to PRODUCT_ID in register OXLD. This is a read-only register. How ever, during the programming of the USID a write command sequence is per- formed on this register, even though the write does not change its value.         00000         No           REV_ID         7.4         MAIN_REVISION         Chip sub revision         0000         No           GSID         7.4         GSID0[3:0]         Primary group slave ID.         0000         No           UDR_RST         7         UDR_RST         Reset all configurable non-RFFE Re- served registers to default values. 0: Normal operation         0         0         Ves           ERR_SUM         7         RESERVED         Reset all configurable non-RFFE Re- served registers to default values. 0: Normal operation         0         Ves           6:0         RESERVED         Reserved for future use         0         0         No           6:1         COMMAND_FRAME_PARITY_ERR         Command Sequence received with par- ity error - discard command.         0         No           7         BID_GID_ERR         Read command to an invalid address.         0         0           7         RESERVED         Read command to an invalid address.         0         0           6         COMMAND_LENGTH_ERR         Command senge write parity error.         0	EXT_PRODUCT_ID         7.0         EXT_PRODUCT_ID         Extension to PRODUCT_ID in register OLD. This is a read-only register. How- ever, during the programming of the USD a write command sequence is per- formed on this register, even though the write does not change its value.         000000         No         No           REV_ID         7.4         MAIN_REVISION         Chip main revision         0000         No         No           GSID         7.4         GSID0(3:0)         Primary group slave ID.         0000         No         No           3:0         SUB_REVISION         Chip sub revision         00000         No         No           GSID         7.4         GSID0(3:0)         Primary group slave ID.         0000         No         No           0         3:0         GSID12:0)         Secondary group slave ID.         00000         No         No           UDR_RST         7         UDR_RST         Reset all configurable non-RFFE Re- served for future use         0         No         No           6:0         RESERVED         Reserved for future use         0         No         No           4         ADDRESS_FRAME_PARITY_ERR         Command Sequence received with par- ity error - discard command.         0         No           1         WRITE_UNUSED_REG         Write command to an invalid addrer



### **MIPI RFFE specification**

#### Table 14: Register mapping, table III

Register address	Register name	Data bits	Function	Description	Default	Broadcast_ID support	Trigger support	R/W
0x2D	EXT_TRIG_MASK	7	TRIGGER_MASK_10	0: Data writes to registers tied to EXT_TRIGGER_10 are masked. Data is held in shadow registers until the EXT_TRIGGER_10 bit is set to 1.	1	No	No	R/W
				<ol> <li>Data writes to registers tied to EXT_TRIGGER_10 are not masked. Data writes go directly to the active registers.</li> </ol>				MW
		6	TRIGGER_MASK_9	<ul> <li>0: Data writes to registers tied to EXT_TRIGGER_9 are masked. Data is held in shadow registers until the EXT_TRIGGER_9 bit is set to 1.</li> <li>1: Data writes to registers tied to EXT_TRIGGER_9 are not masked. Data</li> </ul>	1			
		5	TRIGGER_MASK_8	<ul> <li>writes go directly to the active registers.</li> <li>0: Data writes to registers tied to</li> <li>EXT_TRIGGER_8 are masked. Data</li> <li>is held in shadow registers until the</li> <li>EXT_TRIGGER_8 bit is set to 1.</li> </ul>	1			
				1: Data writes to registers tied to EXT_TRIGGER_8 are not masked. Data writes go directly to the active registers.				
		4	TRIGGER_MASK_7	0: Data writes to registers tied to EXT_TRIGGER_7 are masked. Data is held in shadow registers until the EXT_TRIGGER_7 bit is set to 1.	1			
				<ol> <li>Data writes to registers tied to EXT_TRIGGER_7 are not masked. Data writes go directly to the active registers.</li> </ol>				
		3	TRIGGER_MASK_6	0: Data writes to registers tied to EXT_TRIGGER_6 are masked. Data is held in shadow registers until the EXT_TRIGGER_6 bit is set to 1.	1			
				<ol> <li>Data writes to registers tied to EXT_TRIGGER_6 are not masked. Data writes go directly to the active registers.</li> </ol>				
		2	TRIGGER_MASK_5	0: Data writes to registers tied to EXT_TRIGGER_5 are masked. Data is held in shadow registers until the EXT_TRIGGER_5 bit is set to 1.	1			
				1: Data writes to registers tied to EXT_TRIGGER_5 are not masked. Data writes go directly to the active registers.				
		1	TRIGGER_MASK_4	0: Data writes to registers tied to EXT_TRIGGER_4 are masked. Data is held in shadow registers until the EXT_TRIGGER_4 bit is set to 1.	1	-		
				1: Data writes to registers tied to EXT_TRIGGER_4 are not masked. Data writes go directly to the active registers.				
		0	TRIGGER_MASK_3	0: Data writes to registers tied to EXT_TRIGGER_3 are masked. Data is held in shadow registers until the EXT_TRIGGER_3 bit is set to 1.	1			
				1: Data writes to registers tied to EXT_TRIGGER_3 are not masked. Data writes go directly to the active registers.				



### **MIPI RFFE specification**

#### Table 15: Register mapping, table IV

Register address	Register name	Data bits	Function	Description	Default	Broadcast_ID support	Trigger support	R/W	
0x2E	EXT_TRIG	7	TRIGGER_10	0: No action. Data is held in shadow reg- isters.	0	Yes	No	R/W	
			1: Data is transferred from shadow reg- isters to active registers for refisters tied to EXT_TRIGGER_10				MW		
		6	TRIGGER_9	0: No action. Data is held in shadow reg- isters.	0				
				1: Data is transferred from shadow reg- isters to active registers for refisters tied to EXT_TRIGGER_9					
		5	TRIGGER_8	0: No action. Data is held in shadow reg- isters.	0				
			1: Data is transferred from shadow reg- isters to active registers for refisters tied to EXT_TRIGGER_8						
	4	TRIGGER_7	0: No action. Data is held in shadow reg- isters.	0					
			1: Data is transferred from shadow reg- isters to active registers for refisters tied to EXT_TRIGGER_7						
		3	3	TRIGGER_6	0: No action. Data is held in shadow reg- isters.	0			
				1: Data is transferred from shadow reg- isters to active registers for refisters tied to EXT_TRIGGER_6					
		2	TRIGGER_5	0: No action. Data is held in shadow reg- isters.	0				
			1: Data is transferred from shadow reg- isters to active registers for refisters tied to EXT_TRIGGER_5						
	1	TRIGGER_4	0: No action. Data is held in shadow reg- isters.	0					
			1: Data is transferred from shadow reg- isters to active registers for refisters tied to EXT_TRIGGER_4						
		0	TRIGGER_3	0: No action. Data is held in shadow reg- isters.	0				
			1: Data is transferred from shadow reg- isters to active registers for refisters tied to EXT_TRIGGER_3						

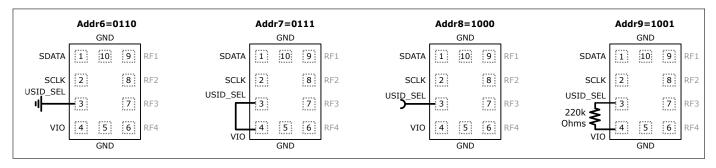


#### **MIPI RFFE specification**

#### **Table 16: Default MIPI USID selection**

Address	Symbol	External conditon at USID_SEL Pin
USID=0110	Addr6	Ground
USID=0111	Addr7	to VIO
USID=1000	Addr8	Floating <sup>1)</sup>
USID=1001	Addr9	220 k $\Omega$ to VIO <sup>1)</sup>

<sup>1)</sup> Total capacitance on the USID\_SEL pin must be <5 pF.







#### **MIPI RFFE specification**

Warning: Register\_0 and Register\_1 RF switch control bits are identical. Writing both registers Register\_0 and Register\_1 simultaneously will lead to undefined behavior. The unused register (Register\_0 or Register\_1) must remain 0x00.

State	Mode	D7	D6	D5	D4	D3	D2	D1	DO
0	ALL OFF (Isolation)	x	х	х	х	0	0	0	0
1	RF1 ON	x	x	х	х	0	0	0	1
2	RF2 ON	x	х	х	х	0	0	1	0
3	RF1+RF2 ON	х	х	х	х	0	0	1	1
4	RF3 ON	x	х	х	х	0	1	0	0
5	RF1+RF3 ON	х	х	х	х	0	1	0	1
6	RF2+RF3 ON	х	х	х	х	0	1	1	0
7	RF1+RF2+RF3 ON	х	х	х	х	0	1	1	1
8	RF4 ON	х	х	х	х	1	0	0	0
9	RF1+RF4 ON	х	х	х	х	1	0	0	1
10	RF2+RF4 ON	х	х	х	х	1	0	1	0
11	RF1+RF2+RF4 ON	х	х	х	х	1	0	1	1
12	RF3+RF4 ON	х	х	х	х	1	1	0	0
13	RF1+RF3+RF4 ON	х	х	х	х	1	1	0	1
14	RF2+RF3+RF4 ON	х	х	х	х	1	1	1	0
15	RF1+RF2+RF3+RF4 ON	х	х	х	х	1	1	1	1

#### Table 17: Modes of operation (Truth table, Register\_0)

<sup>1)</sup>Do not care, x = 0 or 1

#### Table 18: Modes of operation (Truth table, Register\_1)

State	Mode	D7	D6	D5	D4	D3	D2	D1	DO
0	ALL OFF (Isolation)	х	х	x	х	0	0	0	0
1	RF1 ON	х	х	x	х	0	0	0	1
2	RF2 ON	х	х	x	х	0	0	1	0
3	RF1+RF2 ON	х	х	x	х	0	0	1	1
4	RF3 ON	х	x	x	х	0	1	0	0
5	RF1+RF3 ON	х	х	x	х	0	1	0	1
6	RF2+RF3 ON	х	х	x	х	0	1	1	0
7	RF1+RF2+RF3 ON	х	x	x	х	0	1	1	1
8	RF4 ON	х	х	x	х	1	0	0	0
9	RF1+RF4 ON	х	х	x	х	1	0	0	1
10	RF2+RF4 ON	х	х	x	х	1	0	1	0
11	RF1+RF2+RF4 ON	х	х	x	х	1	0	1	1
12	RF3+RF4 ON	х	x	x	х	1	1	0	0
13	RF1+RF3+RF4 ON	х	x	x	х	1	1	0	1
14	RF2+RF3+RF4 ON	х	х	x	х	1	1	1	0
15	RF1+RF2+RF3+RF4 ON	х	x	x	х	1	1	1	1

<sup>1)</sup>Do not care, x = 0 or 1



Application information

### **6** Application information

### Pin configuration and function

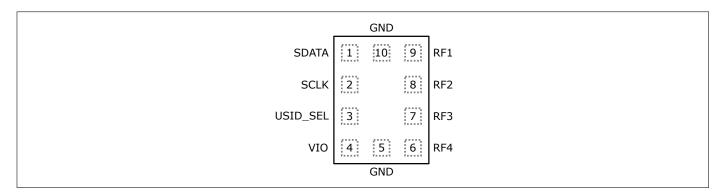


Figure 4: BGSA400ML10 pin configuration (top view)

#### Table 19: Pin definition and function

Pin No.	Name	Function
1	SDATA	MIPI RFFE data input / output
2	SCLK	MIPI RFFE clock input
3	USID_SEL	USID default address selection pin (see Tab. 16)
4	VIO	Voltage supply compatible with MIPI RFFE specification
5	GND	Ground
6	RF4	RF4 port
7	RF3	RF3 port
8	RF2	RF2 port
9	RF1	RF1 port
10	GND	Ground

### BGSA400ML10

#### Ultra high RF voltage antenna tuning switch



**Application information** 

#### **Evaluation board description**

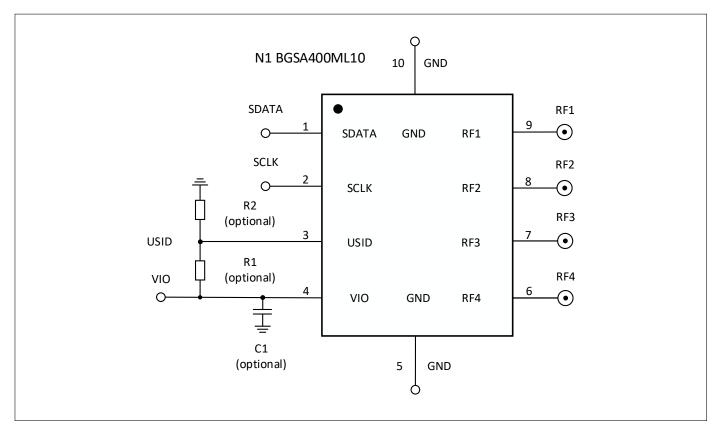


Figure 5: BGSA400ML10 application schematic

#### Table 20: Bill of materials

Name	Part type	Package	Manufacturer	Function	
C1 (1nF optional) <sup>1)</sup>	Capacitor	0402	Various	De-coupling capacitor	
N1	BGSA400ML10	TSLP-10-3	Infineon	Antenna tuner	
R1 (do not place)	Resistor	0402	Various	Set USID default address	
R2 (0 Ohm)				to 6 (GND)	
R1 (0 Ohm)	Resistor	0402	Various	Set USID default address	
R2 (do not place)				to 7 (VIO)	
R1 (do not place)	Resistor	0402	Various	Set USID default address	
R2 (do not place)				to 8 (FLOATING)	
R1 (220 kOhm)	Resistor	0402	Various	Set USID default address	
R2 (do not place)				to 9 (220 kOhm to VIO)	

<sup>1)</sup> This capacitor is optional and value is only indicative. Decoupling capacitor value has to be chosen in order VIO ramp-up time is within MIPI RFFE version v2.1 specification.



Package information

### 7 Package information

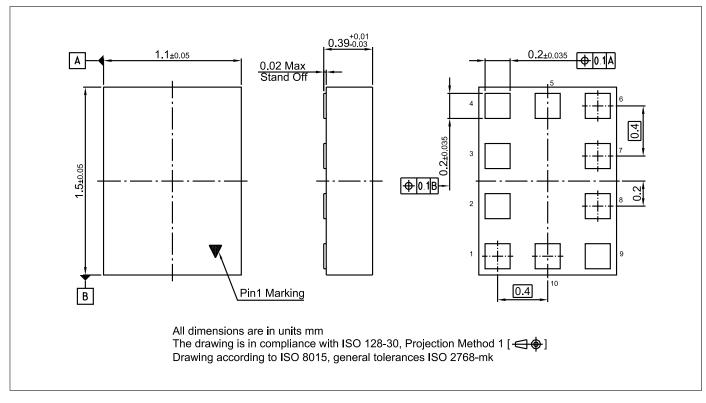
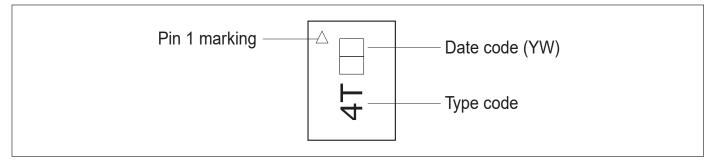
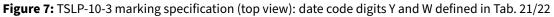


Figure 6: TSLP-10-3 package outline (top, side and bottom views)







#### Package information

			-	-	
Year	"Y"	Year	"Y"	Year	"Y"
2010	0	2020	0	2030	0
2011	1	2021	1	2031	1
2012	2	2022	2	2032	2
2013	3	2023	3	2033	3
2014	4	2024	4	2034	4
2015	5	2025	5	2035	5
2016	6	2026	6	2036	6
2017	7	2027	7	2037	7
2018	8	2028	8	2038	8
2019	9	2029	9	2039	9

### Table 21: Year date code marking - digit "Y"

Table 22: Week date	code marking	- digit "W"
---------------------	--------------	-------------

Week	"W"								
1	A	12	N	23	4	34	h	45	v
2	В	13	Р	24	5	35	j	46	x
3	С	14	Q	25	6	36	k	47	у
4	D	15	R	26	7	37	l	48	z
5	E	16	S	27	а	38	n	49	8
6	F	17	Т	28	b	39	р	50	9
7	G	18	U	29	с	40	q	51	2
8	н	19	V	30	d	41	r	52	3
9	J	20	W	31	e	42	S	53	М
10	к	21	Y	32	f	43	t		
11	L	22	Z	33	g	44	u		



#### Package information

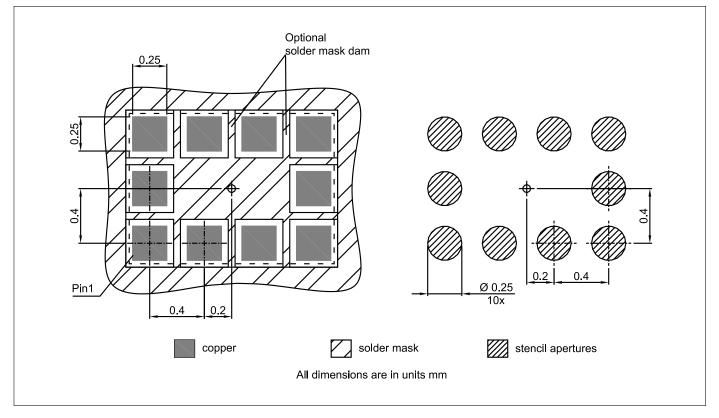


Figure 8: TSLP-10-3 footprint recommendation

### BGSA400ML10

### Ultra high RF voltage antenna tuning switch



#### Package information

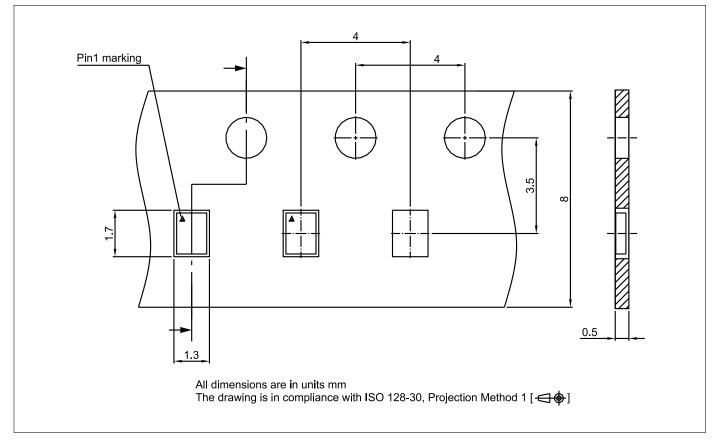


Figure 9: TSLP-10-3 carrier tape

<b>Revision history</b>		
Page or item	Subjects (major changes since previous revision)	
Revision 2.1, 202	22-01-31	
Title page	Package drawing added	
7	Note / Test condition for parameter "RF operating voltage" updated	

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